

N85-32437

## SILICON RIBBON STRESS-STRAIN ACTIVITIES

JET PROPULSION LABORATORY

B.K. Wada  
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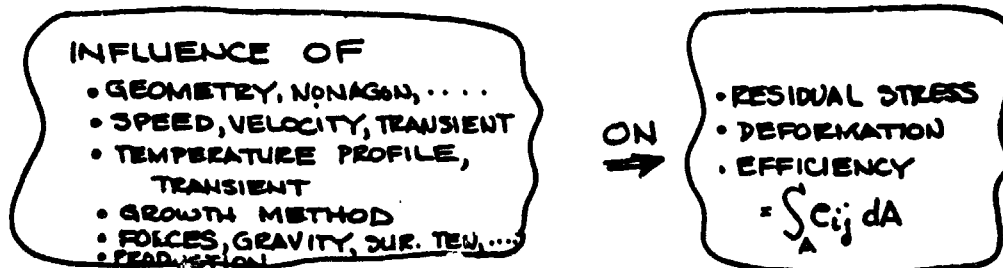
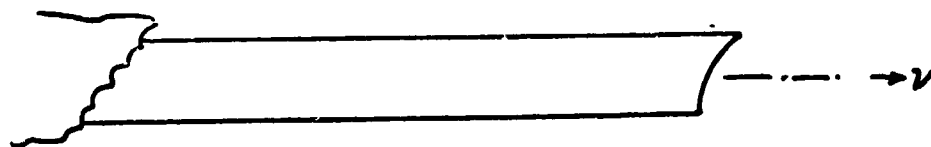
## Objective

PRESENT PRELIMINARY RESULTS

- STRESS - STRAIN
- MATERIAL PROPERTIES

## Ultimate Goal

- ULTIMATE GOAL - ANALYTICAL SIMULATION



- VALUABLE FOR
  - LOWER COST, LOWER YIELD
  - HIGH EFFICIENT CELLS

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## JPL Stress-Strain Effort

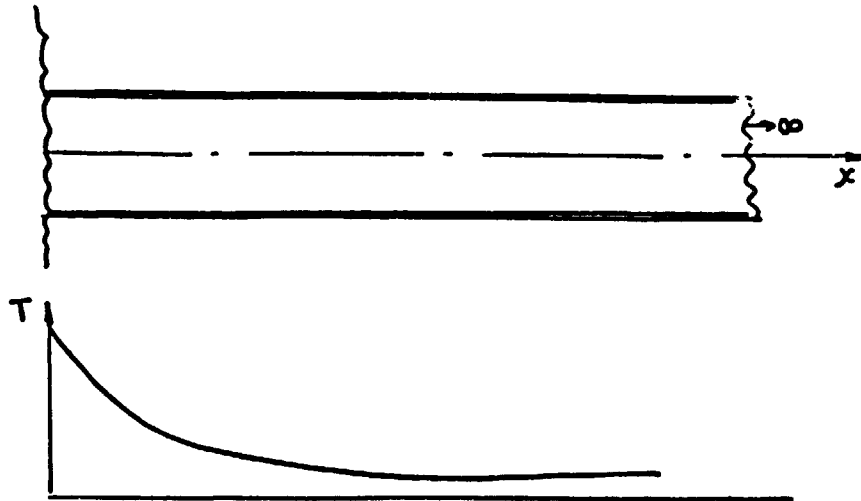
- USE EXISTING FINITE ELEMENT CODES
  - FLEXIBILITY IN GEOMETRY
- TWO APPROACHES

I. QUASI-STATIC  
NASTRAN  
DR. C-F SHIH

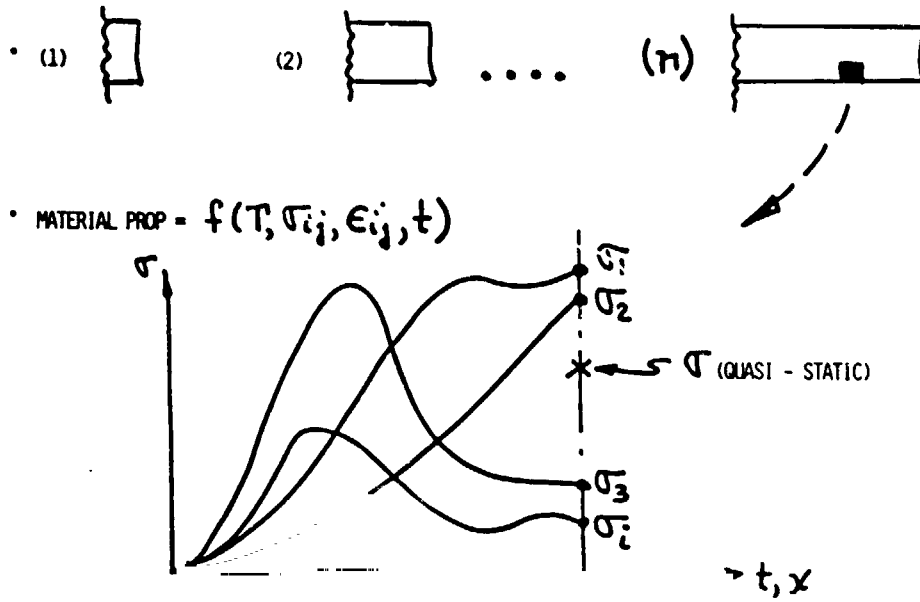
II. IN-PROCESS GROWTH  
ANSYS  
DR. C. P. KUO

- TOTAL PROBLEM
  - STRESS, BUCKLING, MATERIAL NON-LINEARITY, CREEP, IMPERFECTION -----> WHAT'S CRITICAL?
  - PARAMETRIC STUDY -----> VARY ENGINEERING PARAMETERS
    - -----> SUPPORT PROJECT

### Quasi-Static



In-Process Growth

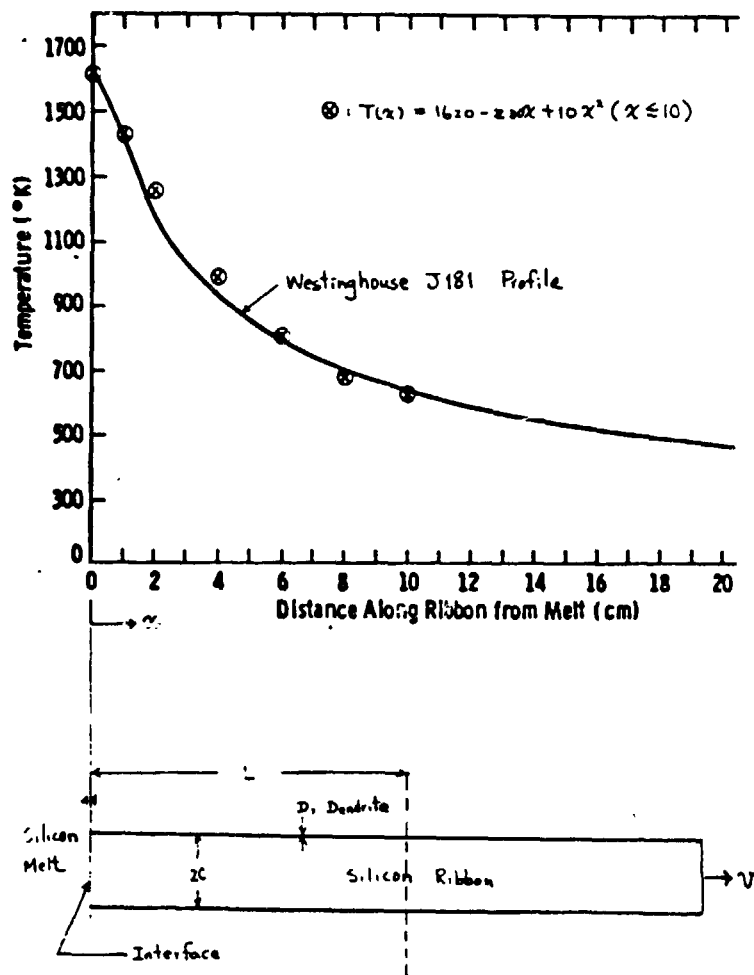


Failure Considerations

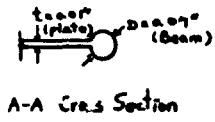
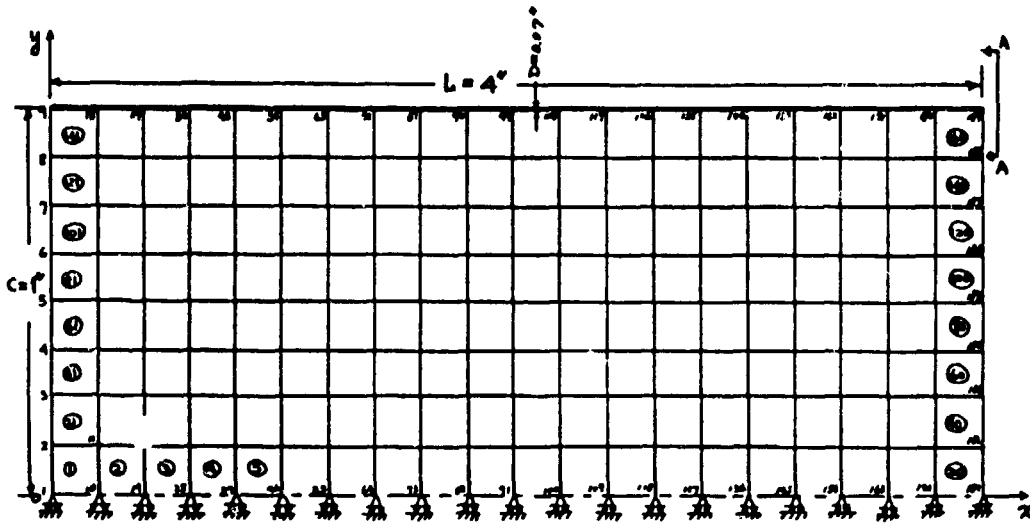
- HIGH FINAL RESIDUAL STRESS -----> HANDLING PROBLEMS
- HIGH IN-PROCESS RESIDUAL STRESS -----> DISLOCATIONS -----> LOW EFFICIENCIES
- BUCKLING -----> DEFORMED PRODUCTS -----> INSTALLATION -----> BREAKAGE

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## Temperature Profile

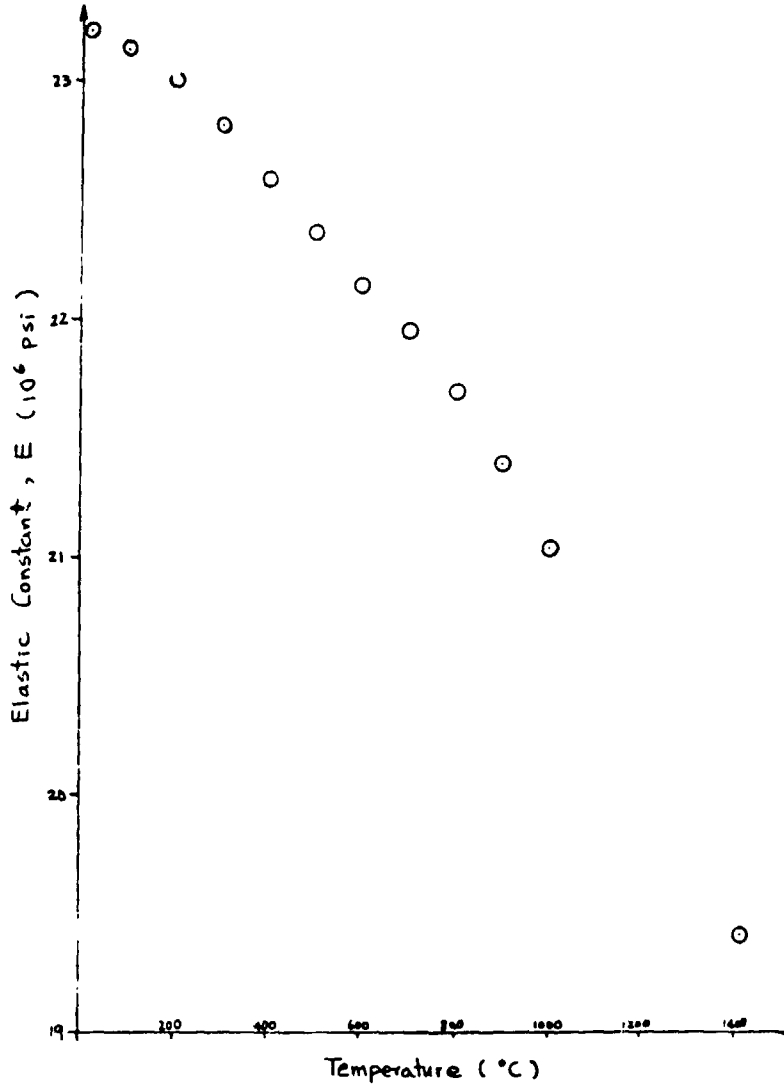


ORIGINAL PAGE IS  
OF POOR QUALITY  
Finite Element Model of 4 × 2 in. Silicon Ribbon



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Elastic Constant as a Function of Temperature (Burenkov)



Stress Contours and Their Corresponding Stress Levels

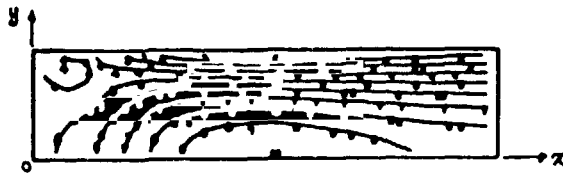


Fig. 3a X-X Normal Stresses

No.	$\sigma_{xx}$ (Psi)
1	-3.017484E+03
2	-2.202389E+03
3	-1.367321E+03
4	-3.722522E+02
5	2.426183E+02
6	1.857685E+03
7	1.872051E+03
8	2.860322E+03
9	3.803090E+03
10	4.312159E+03



Fig. 3b Y-Y Normal Stresses

No.	$\sigma_{yy}$ (Psi)
1	-1.864383E+04
2	-9.206611E+03
3	-7.729806E+03
4	-6.273180E+03
5	-4.816464E+03
6	-3.359709E+03
7	-1.902282E+03
8	-4.463157E+02
9	1.010403E+03
10	2.467187E+03

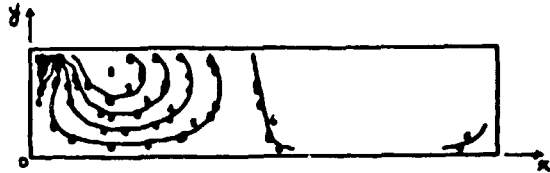


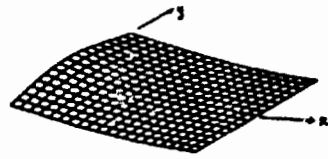
Fig. 3c X-Y Shear Stresses

No.	$\sigma_{xy}$ (Psi)
1	-2.408780E+03
2	-1.894588E+03
3	-1.422297E+03
4	-9.020589E+02
5	-4.858147E+02
6	3.042681E+01
7	5.164697E+02
8	1.802989E+03
9	1.469150E+03
10	1.975391E+03

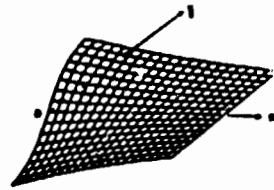
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OF POOR QUALITY

$$L = 4 \text{ in.}, c = 1 \text{ in.}, t = 0.01 \text{ in.}, D = 0.07 \text{ in.}$$

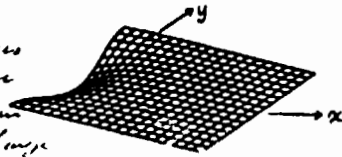


1st Mode  
 $\lambda_1 = 0.2126$

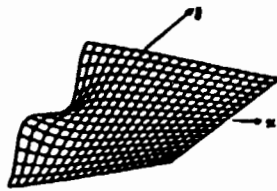


2nd Mode  
 $\lambda_2 = 0.2281$

*Multiplicities times  
stress used for  
buckling. To obtain  
buckling stress, compare  
with  $\lambda = 1.0$ .*



3rd Mode  
 $\lambda_3 = 0.3987$



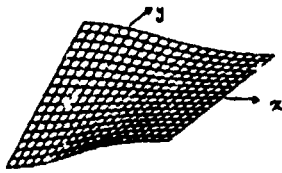
4th Mode  
 $\lambda_4 = 0.7289$



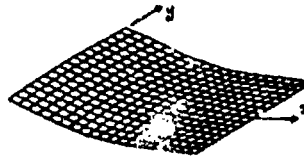
5th Mode  
 $\lambda_5 = 1.1649$



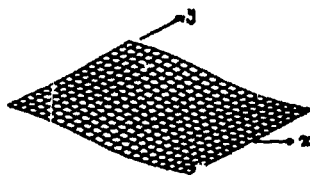
First Five Buckling Modes of EFG Ribbon ( $D = 0.0$  in.)



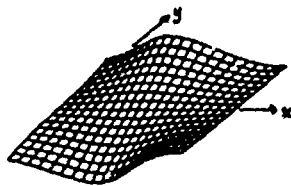
1st Mode  
 $\lambda_1 = 0.3632$



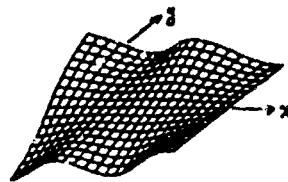
2nd Mode  
 $\lambda_2 = 0.3786$



3rd Mode  
 $\lambda_3 = 0.5142$



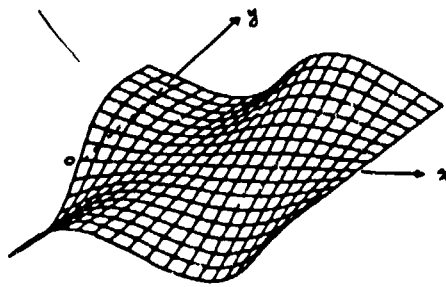
4th Mode  
 $\lambda_4 = 0.5479$



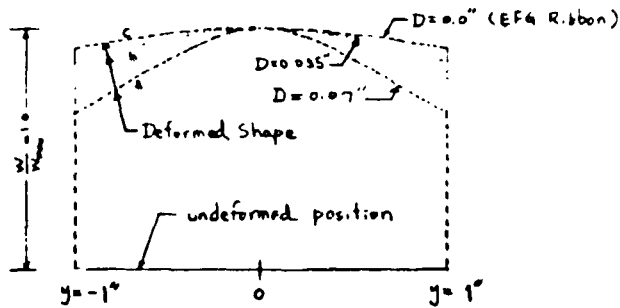
5th Mode  
 $\lambda_5 = 0.7762$

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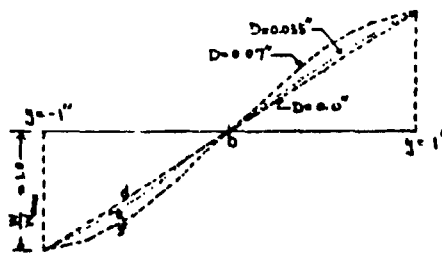
Buckling Mode (D = 0.035 in.)



Buckling Mode Shapes at Melt Interface (x = 0) and Their Corresponding Eigenvalues



- a.  $\lambda_1 = 0.2126$  (1st mode)
- b.  $\lambda_1 = 0.3289$  (1st mode)
- c.  $\lambda_1 = 0.3786$  (2nd mode)



- d.  $\lambda_1 = 0.3632$  (1st mode)
- e.  $\lambda_2 = 0.3964$  (2nd mode)
- f.  $\lambda_2 = 0.2281$  (2nd mode)

CHARACTERISTICS OF POSITION

ORIGINAL FILM IS  
OF POOR QUALITY.

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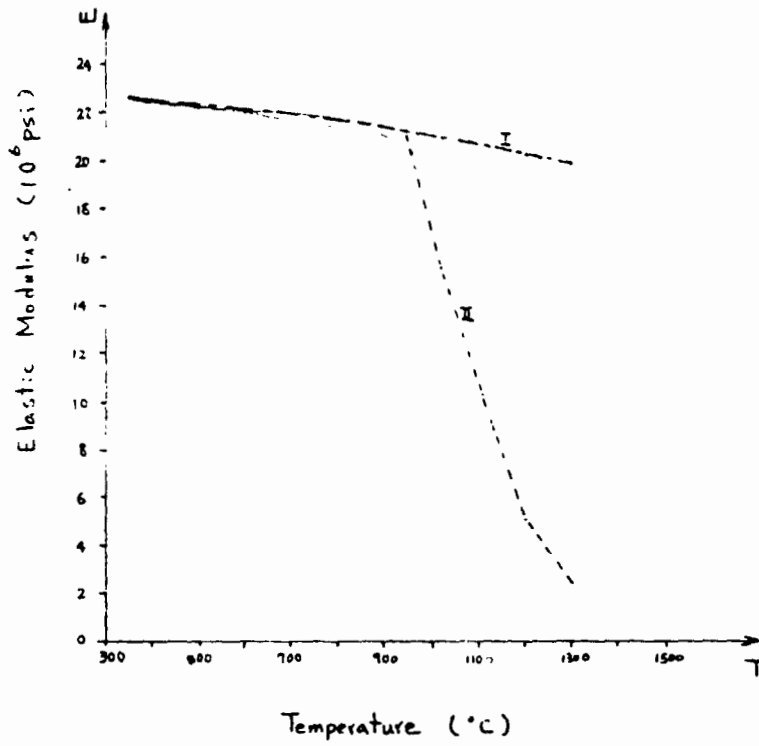
Dendrites Effect

	D = 0.07"	D = 0.035"	D = 0.0"
$\sigma_x$	-3017 psi +4318 psi	-5011 psi +3792 psi	-2043 psi +2396 psi
$\Delta\sigma_x$	7335 psi	8803 psi	9439 psi
$\sigma_y$	-10643 psi +2467 psi	-5990 psi +1648 psi	-4947 psi +1450 psi
$\Delta\sigma_y$	13110 psi	7638 psi	6497 psi
$\lambda_1$	0.213	0.329	0.363
$\lambda_2$	0.228	0.396	0.379

$\lambda$  increases as  $\sigma_y$  (compression) decrease

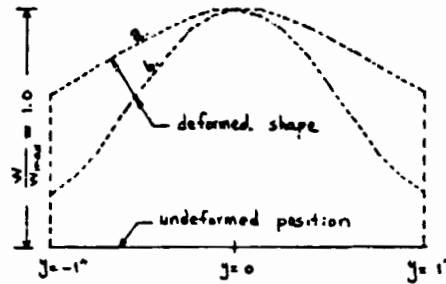
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Influence of Young's Modulus (Sylwestrowica)



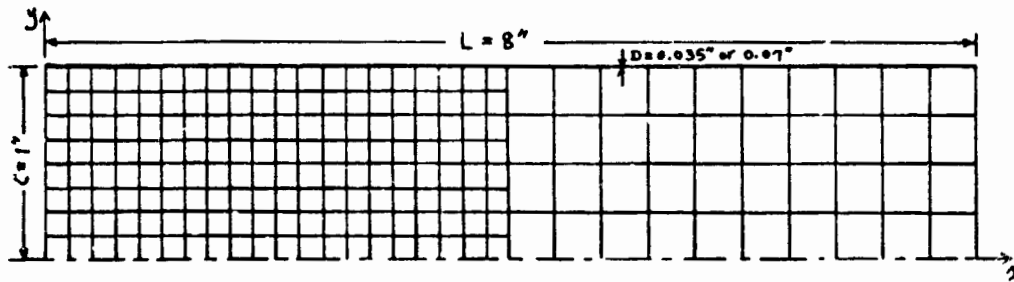
	$E_I$	$E_{II}$
$\sigma_{xx}$	-3017 psi +4318 psi	-2666 psi +3805 psi
$\sigma_{yy}$	-10643 psi + 2467 psi	-3828 psi +1818 psi
$\lambda_1$	0.213	0.085
$\lambda_2$	0.228	0.109

ORIGIN  
OF BUCKLING MODES  
Buckling Mode Shapes at Melt interface ( $x = 0$ )  
and Their Corresponding Eigenvalues

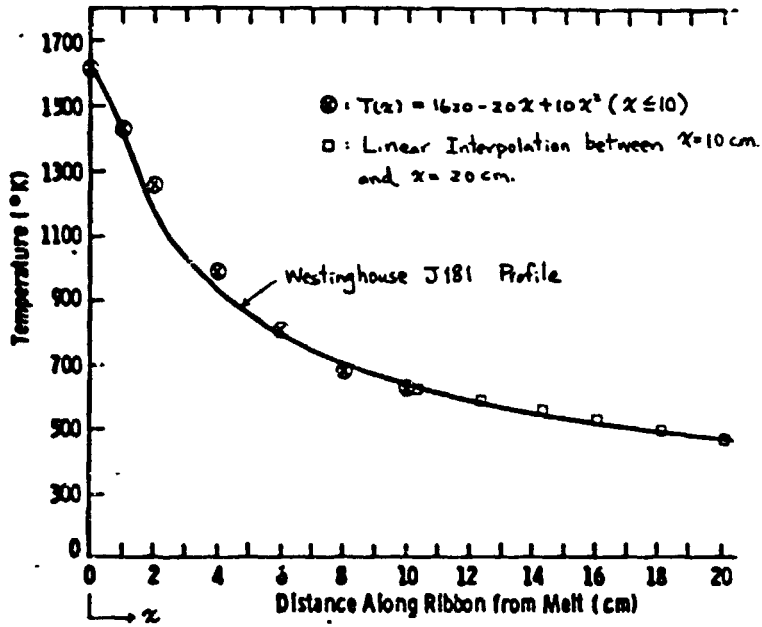


- a.  $\lambda_1 = 0.2126$  (model in ref. 1)  $E_I$
- b.  $\lambda_1 = 0.0849$  (Current Model)  $E_{II}$

Finite Element Model of 8 in.  $\times$  2 in. Silicon Ribbon



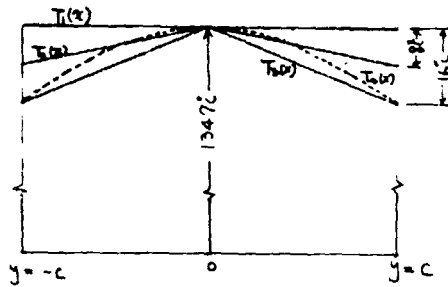
Temperature Profile



	D = 0.07"	D = 0.035"	D = 0.0"
$\sigma_x$	-3017 psi (-2967 psi) + 4318 psi (+4245 psi)	-5011 psi (-5015 psi) + 3792 psi (+3787 psi)	-6043 psi + 3396 psi
$\Delta\sigma_x$	7335 psi	8803 psi	9439 psi
$\sigma_y$	-10643 psi (-10644 psi) + 2467 psi (+2505 psi)	-5990 psi (-5994 psi) + 1648 psi (+1650 psi)	-4997 psi + 1450 psi
$\Delta\sigma_y$	13110 psi	7638 psi	6447 psi
$\lambda_1$	0.213 (0.147)	0.329 (0.311)	0.363
$\lambda_2$	0.228 (0.241)	0.396 (0.393)	0.379
$\lambda_3$	0.399 (0.420)	0.730 (0.707)	

$\lambda$  increases as  $\sigma_y$  (compression) decrease

Temperature Profiles Across the Ribbon Width



Eigenvalues for Corresponding Temperature Profile Acting on a Dendritic Web ( $D = 0.07$  in)

Mode No.	$T_1(x)$	$T_2(x, y)$	$T_3(x, y)$	$T_4(x, y)$
1st	0.2126	0.2150	0.2174	
2nd	0.2281	0.2444	0.2695	0.2705
3rd	0.3987	0.4645	0.4731	0.4751
4th	0.7289	0.7685	0.7853	

Eigenvalues of EFG Ribbon ( $D = 0.0$  in.) Subjected to Two Temperature Profiles

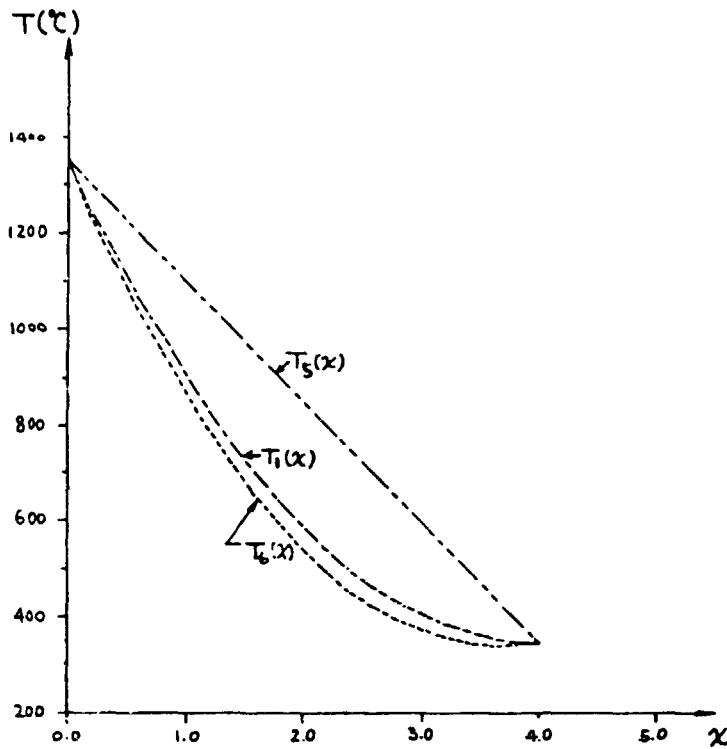
Mode No.	$T_1(x)$	$T_3(x, y)$
1st	0.3632	0.4116
2nd	0.3786	
3rd	0.5142	0.5868

Eigenvalues of EFG Ribbon With Constant Material Properties

Mode No.	$T_1(x)$	$T_2(x, y)$	$T_3(x, y)$
1st	0.632	0.714	0.821
2nd	0.664	0.759	1.112

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## Temperature Profiles Along the Ribbon Length



## Eigenvalues of a Dendritic Web ( $D = 0.07$ in.) Subjected to Two 1-D Temperature Profiles

Mode No.	$T_1(x)$	$T_5(x)$	$T_6(x)$
1st	0.2126	0.295	0.204
2nd	0.2281	0.466	0.244
3rd	0.3987	0.929	0.429
4th	0.7289		



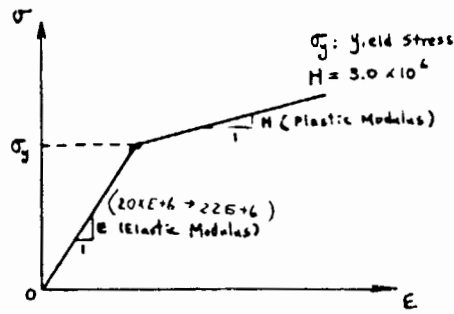
Eigenvalues of Ribbons Subjected  
to Linear Temperature Profile

Mode No.	Dendritic Web $D \neq 0$ $D=0.0; \alpha(T), E(T)$	Dendritic Web $D \neq 0$ $\alpha, E$ are uniform	EFG Ribbon $D=0.0; \alpha(T), E(T)$
1	0.295	0.406	0.566
2	0.466	0.753	0.581
3	0.929		1.087

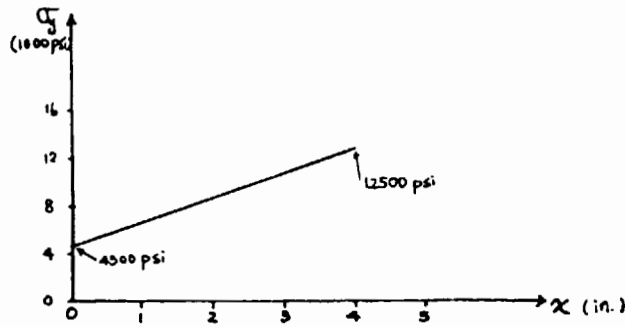
Summary: Linear Buckling Analysis

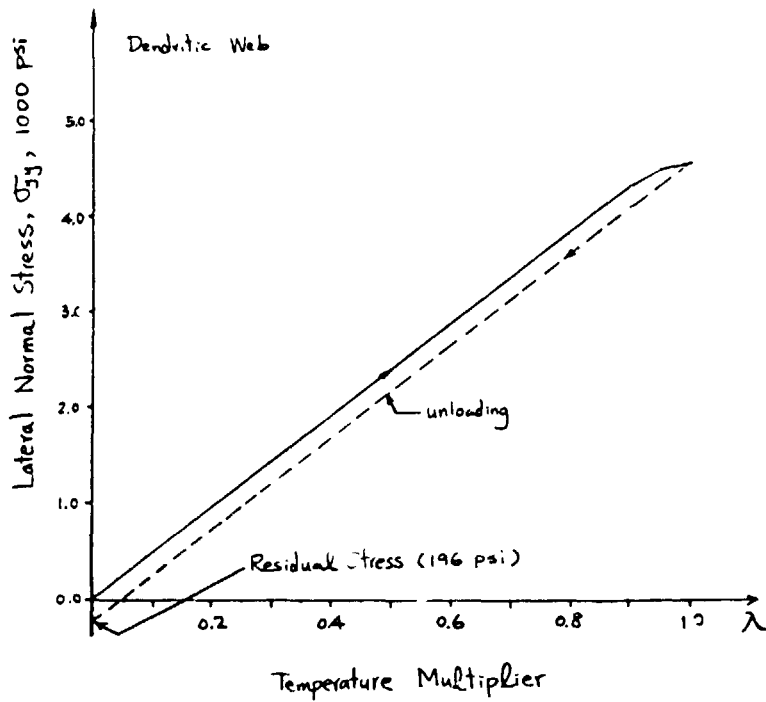
1.  $\sigma_y$  PLAY AN IMPORTANT PART IN THE RIBBON BUCKLING PROBLEM.
2.  $\Delta \sigma_x$  IS NOT AN ADEQUATE DESIGN PARAMETER.
3. BUCKLING MODE INCLUDES BOTH BEAM TYPE AND PLATE TYPE.
4. DENDRITES AFFECT THE THERMAL STRESSES AS WELL AS THE BUCKLING ANALYSIS.
5.  $L = 4$  MODEL PROVIDES SUFFICIENTLY GOOD RESULTS.
6. NEED MORE RELIABLE DATA OF  $E(T)$  FOR  $1000^\circ\text{C} < T < 1400^\circ\text{C}$ .
7. EFFECT OF TEMPERATURE VARIATION ACROSS THE RIBBON WIDTH IS MORE SIGNIFICANT IN THE EFG RIBBON.
8. LINEAR TEMPERATURE PROFILE PROVIDES A SLIGHTLY HIGHER CRITICAL TEMPERATURE MULTIPLIER. A BETTER TEMPERATURE PROFILE SHOULD BE INVESTIGATED TO ACHIEVE ZERO STRESS (IF POSSIBLE).

Elastic-Plastic Stress-Strain Relationship



Yield Stress vs Distance From Interface





Effective Stresses of a Dendritic Web at T(x)

$L = 4''$																			
4795	1897	1523	1328	1170	1164	1178	1133	1050	1001	933									
4692	1283	1107	1231	893	654	620	579	518	532	482									
4611	1090	1627	1290	821	529	429	378	366	364	356									
4576	1140	1363	1230	916	722	673	646	622	588	553									
4565	1283	1073	1158	1022	968	965	954	924	859	808									
4566	1430	795	1045	1102	1164	1198	1196	1164	1078	1013									
4570	1539	541	948	1133	1299	1336	1361	1322	1227	1153									
4575	1599	862	886	1176	1339	1434	1443	1403	1302	1223	1131	1068	972	908	849	797	754	722	720

$\lambda_{min} = 1.02$  (Elastic Buckling)

$\lambda = 0.8$   $\sigma_{max} = 4244$  psi

NO yield

$\lambda = 0.85$   $\sigma_{E(111)} = 4502$  psi

yield on element # 141

$\lambda = 0.90$   $\sigma_{E(111)} = 4514$  psi

yield on elements # 121, # 141

$\sigma_{E(111)} = 4590$  psi

$\lambda = 0.95$   $\sigma_{E(111)} = 4516$  psi ;  $\sigma_{E(111)} = 4605$  psi

$\sigma_{E(111)} = 4511$  psi ;  $\sigma_{E(111)} = 4697$  psi

$\sigma_{E(111)} = 4506$  psi

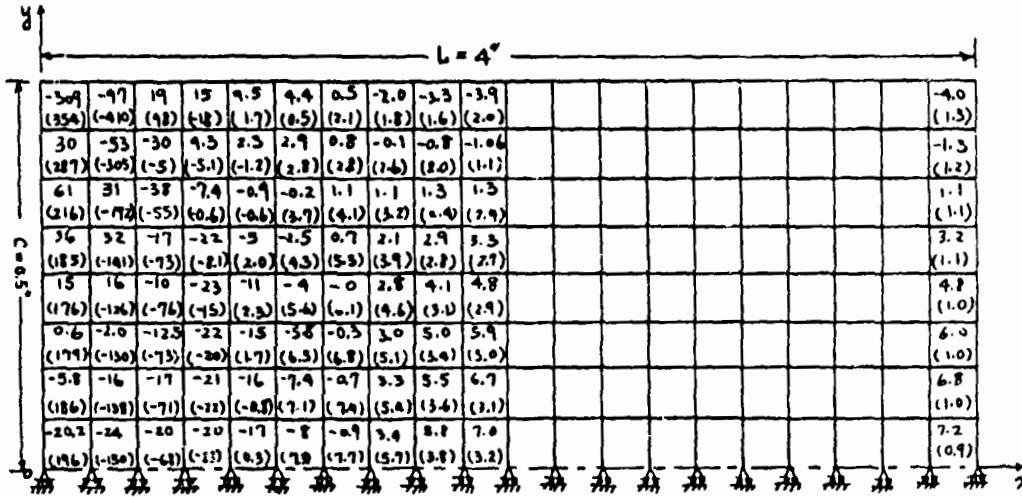
element no.

$\sigma_{E(111)} = 4503$  psi

$\sigma_{E(111)} = 4509$  psi

$\sigma_{E(111)} = 4536$  psi

Residual Stresses on a Dendritic Web at Room Temperature (20°C)



$\sigma_{xx}$ : Residual Stresses of  $\sigma_{xx}$  (x-x Normal Stress)

$\sigma_{yy}$ : Residual Stresses of  $\sigma_{yy}$  (y-y Normal Stress)

$D = 0.07$

$t = 0.015$

$C = 0.5$

$\lambda_{min} = 1.02$

Geometrical Nonlinearity and Imperfection ( $5.0 \times 10^{-4}$  in.)

TABLE 1. Thermal Stresses (PSI) at Each Increment  
( $E = 5.0 \times 10^{-4}$  in.)

$\lambda$	Case I	Case II	Case III
	$\Delta\lambda = 0.05$ "SEMION" Method	$\Delta\lambda = 0.025$ "SEMION" Method	$\Delta\lambda = 0.025$ "ITER" Method
0.10	-515.5 -483.7	-515.5 -483.7	-515.0 -484.2
0.125		-644.5 -604.5	-644.2 -604.9
0.15	-773.6 -725.0	Numerical Unstable	-773.2 -725.5
0.175			Diverging
0.20	<del>Negative Diverging</del> Numerical Unstable		
0.225			

Creep Analysis

- CREEP LAW

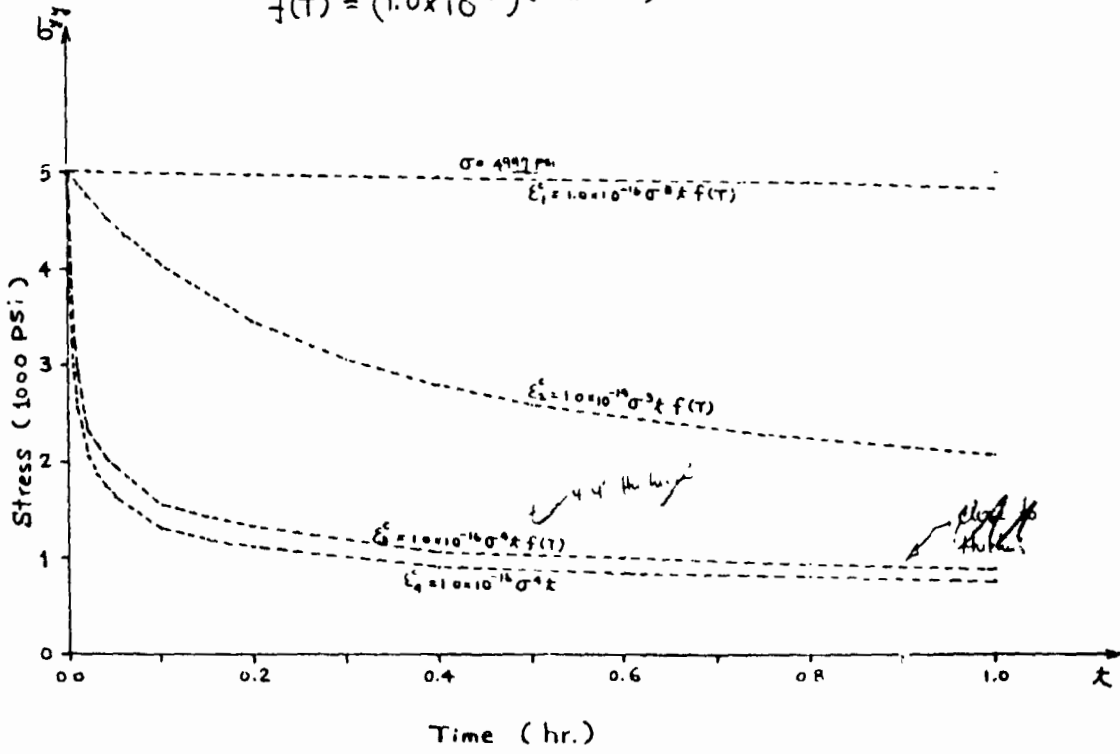
$$\epsilon^c = a \sigma^b c^{(T_0/T-1)} t$$

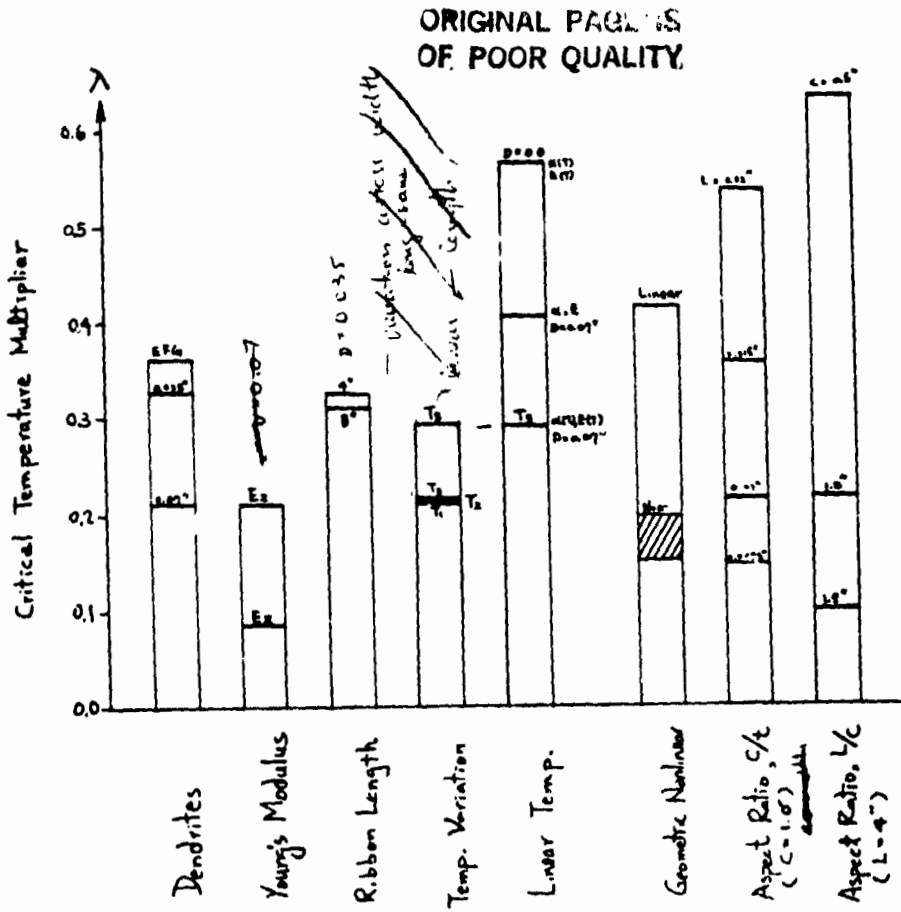
- RESULTS

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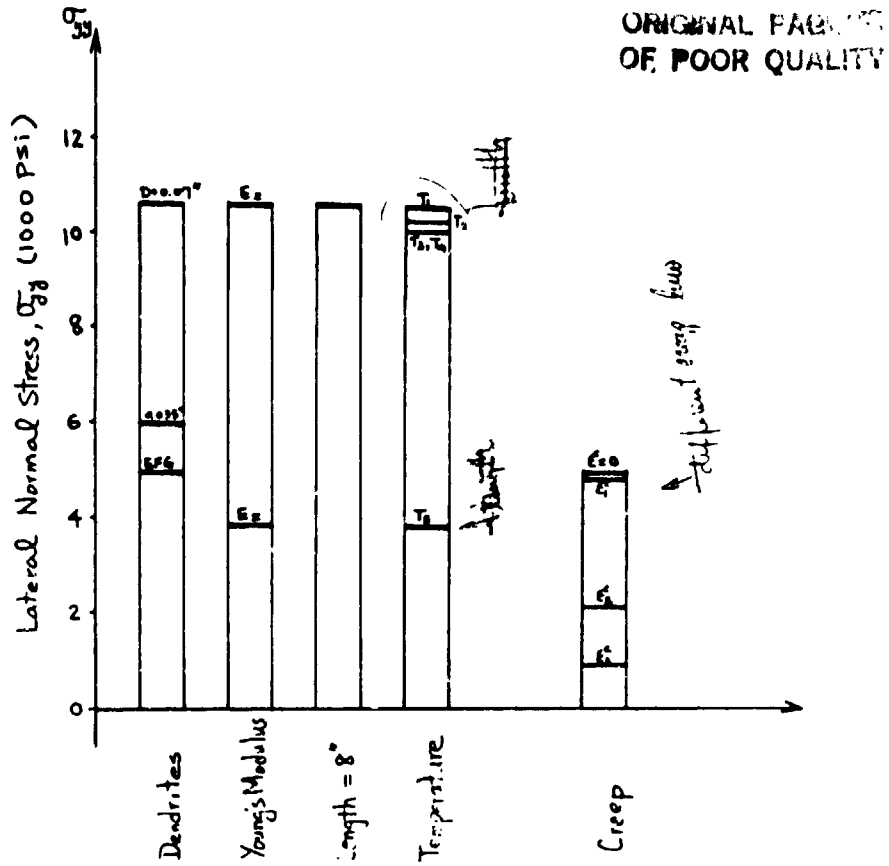
$$\epsilon^c = a \sigma^b c^{(v-1)}$$

$$f(T) = (1.0 \times 10^{-5}) (T/T_0 - 1)$$

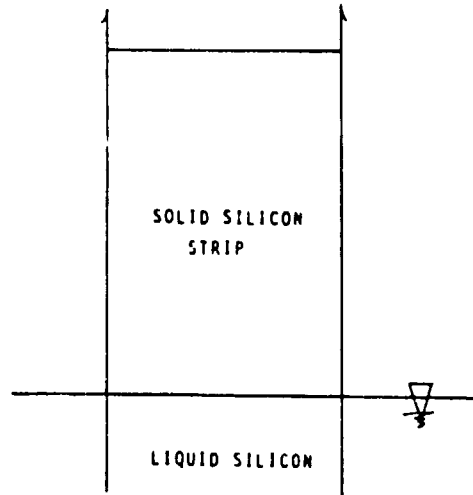




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What Is the Pull-Up Process?





MATERIAL PROPERTIES ARE:

- (1) HOMOGENEOUS AND ISOTROPIC (NO CRACKING, DISLOCATIONS, ETC.)
- (2) MECHANICAL PROPERTIES OF SILICON BEING A FUNCTION OF TEMPERATURE ONLY (NOT A FUNCTION OF STRESS OR STRAIN)
- (3) HAVING A BI-LINEAR STRESS-STRAIN CURVE (TRUE STRESS-STRAIN CAN BE USED)
- (4) HAVING A PRIMARY AND A SECONDARY CREEP FUNCTION

$$\frac{d\epsilon_{cr}}{dt} = c_1 \sigma^{c_2} \epsilon^{c_3} e^{-\frac{c_4}{T}} + c_7 \sigma^{c_8} e^{-\frac{c_{10}}{T}}$$

$c_1, c_2, c_3, c_4, c_7, c_8, c_{10}$  = CONSTANTS

$\epsilon$  = EQUIVALENT STRAIN

$\sigma$  = EQUIVALENT STRESS

$T$  = TEMPERATURE (ABSOLUTE)

## Methods, Criteria and Model Used in the Analysis

- (1) FINITE ELEMENT METHOD
- (2) ANSYS (GENERAL PURPOSE STRUCTURAL ANALYSIS PROGRAM)
  - 2-DIMENSIONAL ISOPARAMETRIC PLANE STRESS ELEMENT
  - 3-DIMENSIONAL ELEMENT
  - CAPABILITIES: PLASTICITY, CREEP, LARGE DEFORMATION, STRESS STIFFNESS, ETC.
- (3) MODEL:
  - 2" WIDE AND 4" LONG STRIP
  - 294 D.O.F., 100 2-D PLANE STRESS QUADRILATERAL ELEMENTS
  - 20 3-D BEAM ELEMENTS (FOR DENDRITE)
- (4) CRITERIA:
  - TEMPERATURE IS CONSTANT Laterally (ACROSS THE WIDTH)